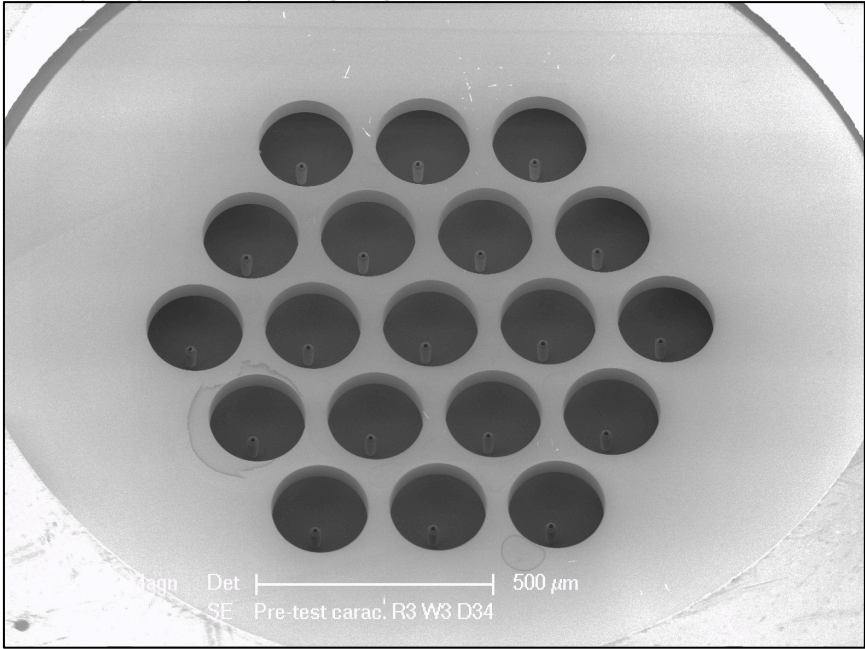


MicroThrust - Microsystems as a solution to enable high ΔV electric propulsion for small spacecraft



19x Emitter array - MicroThrust

S. Dandavino, C. Ataman, S. Chakraborty and H. Shea
EPFL, Switzerland

C. Ryan and J. Stark
Queen Mary University of London, UK

Why miniaturized propulsion?

- Electrical propulsion has been around for years!
 - BUT, too large, heavy and power hungry to be applied to small satellites (1-100 kg)
- Small satellites, with efficient propulsion, could enable:
 - Low cost technology demonstrators (e.g. for MEMS in space)
 - Low cost, low risk, science missions
 - Distributed small satellites networks
 - Clean space debris?



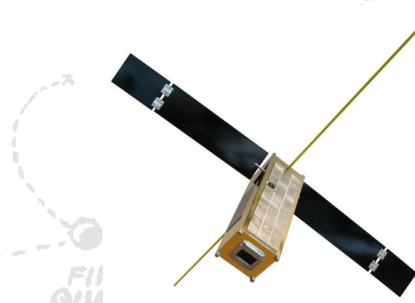
e.g.: 8 cm XIPS® from L-3 communications

http://www2.l-3com.com/eti/product_lines_electric_propulsion.htm

- 2kg (without propellant, HV electronics & high pressure feed)
- 100-300W



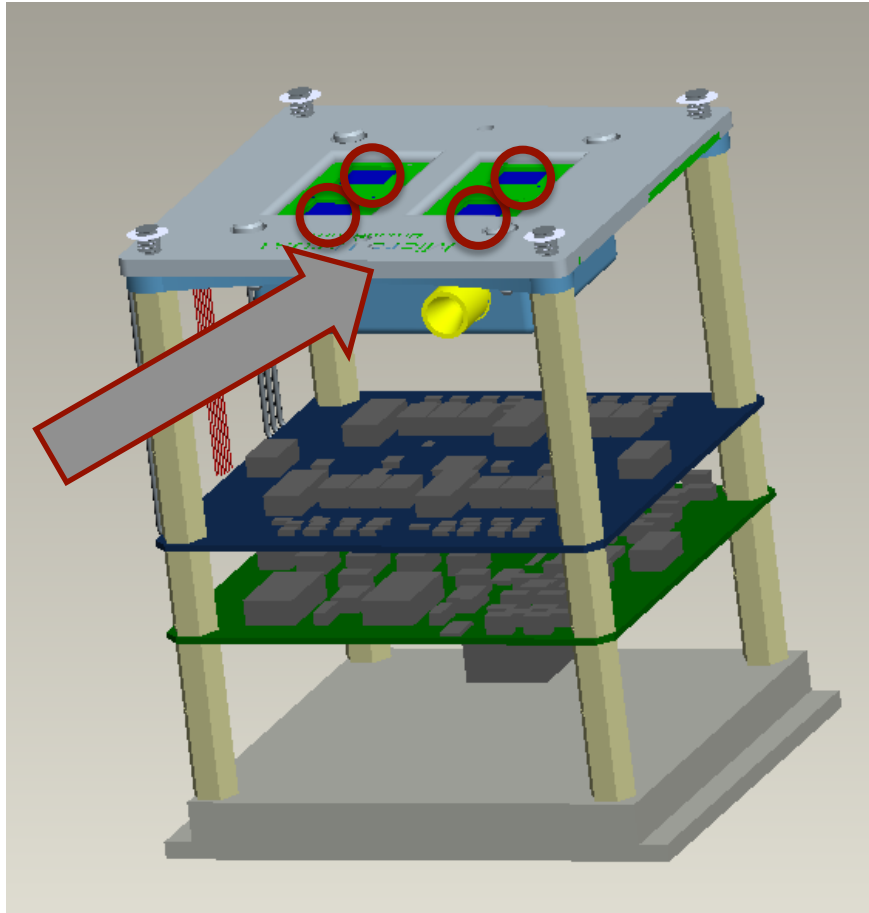
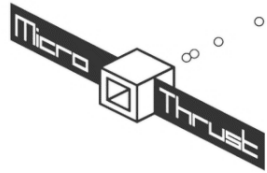
Clean Space One concept – © Swiss Space Center



OLFAR mission

*of moon around earth,
ound itself, and earth around sun,
n same direction*

MicroThrust: Developing a thruster system for small spacecraft



Complete module (concept):

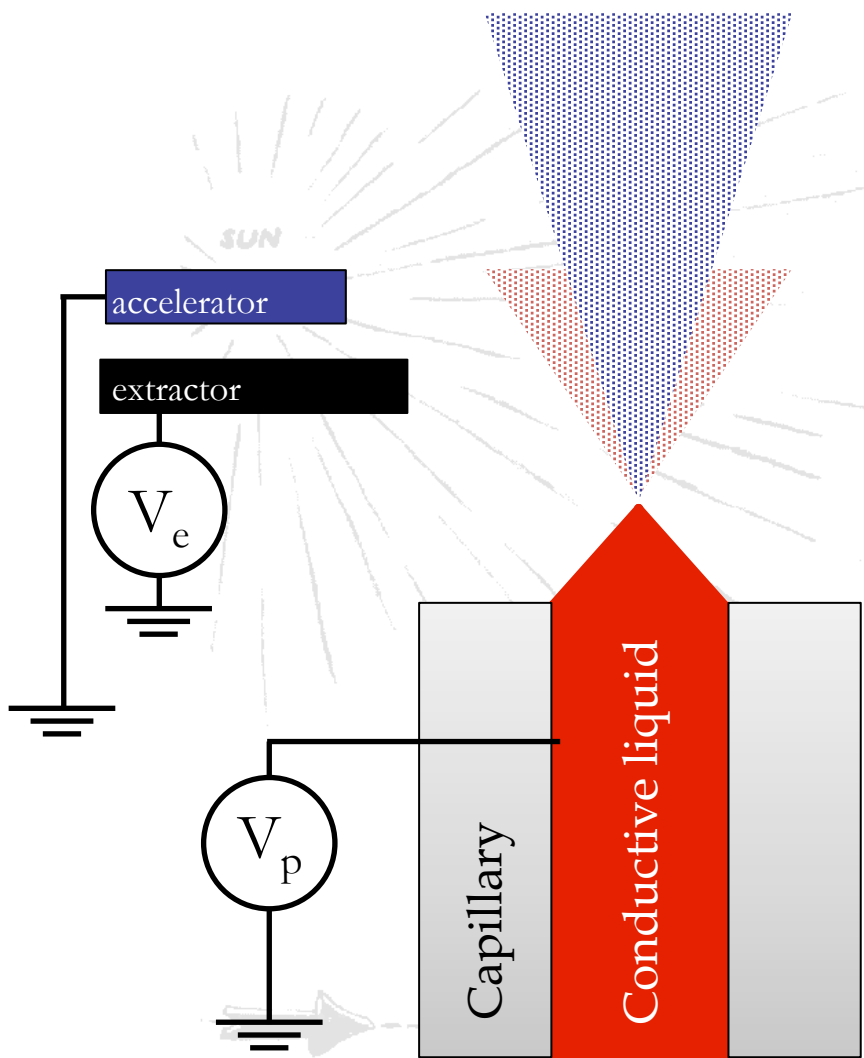
- Wet mass: < 300g / kg of launch (30%)
- Power: < 5 W @ 3.5 kV
- Dimensions: < 10cm x 10cm x 10cm
- Isp: > 3000s
- Thrust: 20 μ N/W
- ΔV : 5 km/s

Partners:

- EPFL (Switzerland)
- Queen Mary University of London (UK)
- Nanospace (Sweden)
- TNO & SystematIC (Netherlands)

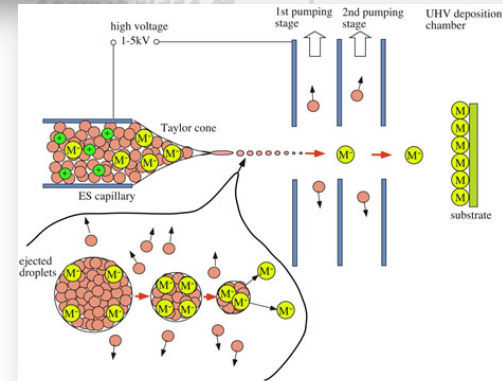
<http://www.microthrust.eu>

Basic operation of electrosprays



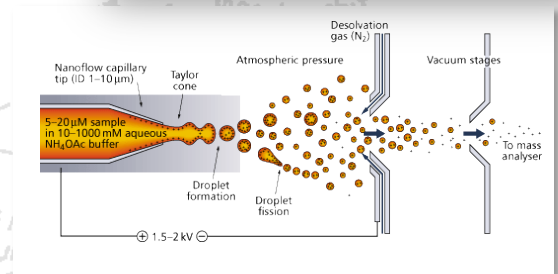
Industrial painting
<http://youtu.be/leapiWpg0Gc>

Thin film deposition
<http://rsl.eng.usf.edu/Pages/ResearchElectrospray.html>



$$I_{sp} = \frac{1}{g} \sqrt{2\Phi_B \frac{q}{m_o}}$$

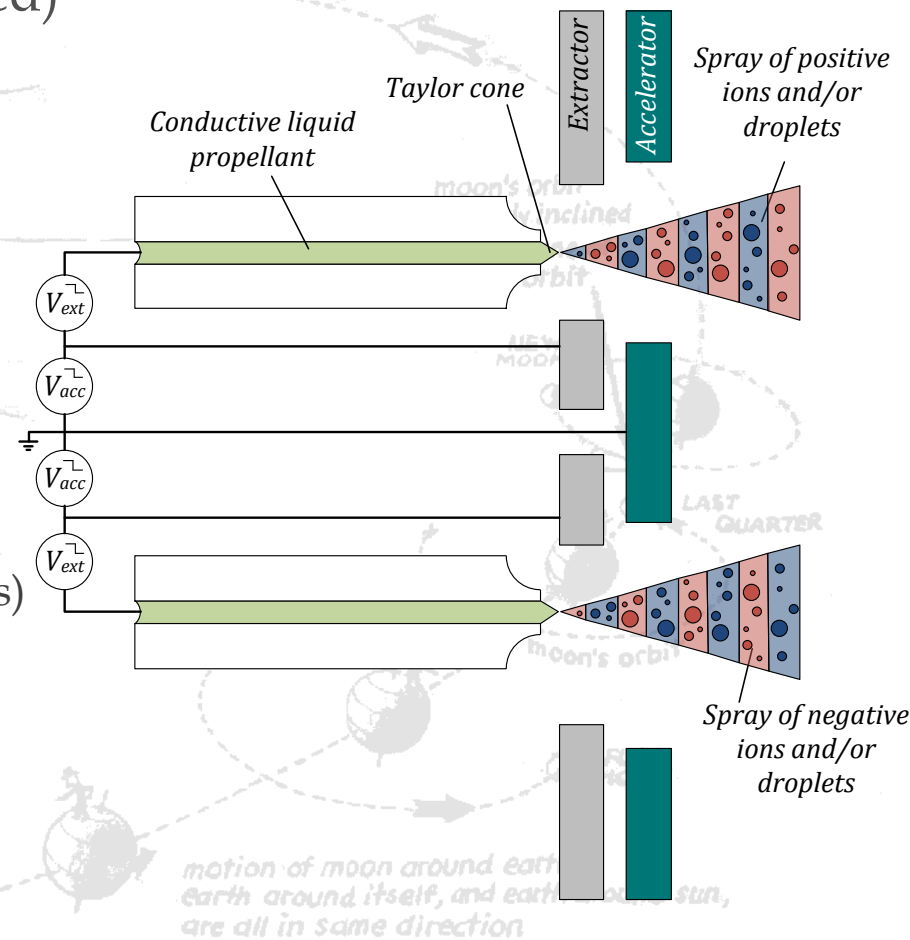
$$T = I \sqrt{2\Phi_B \frac{m_o}{q}}$$



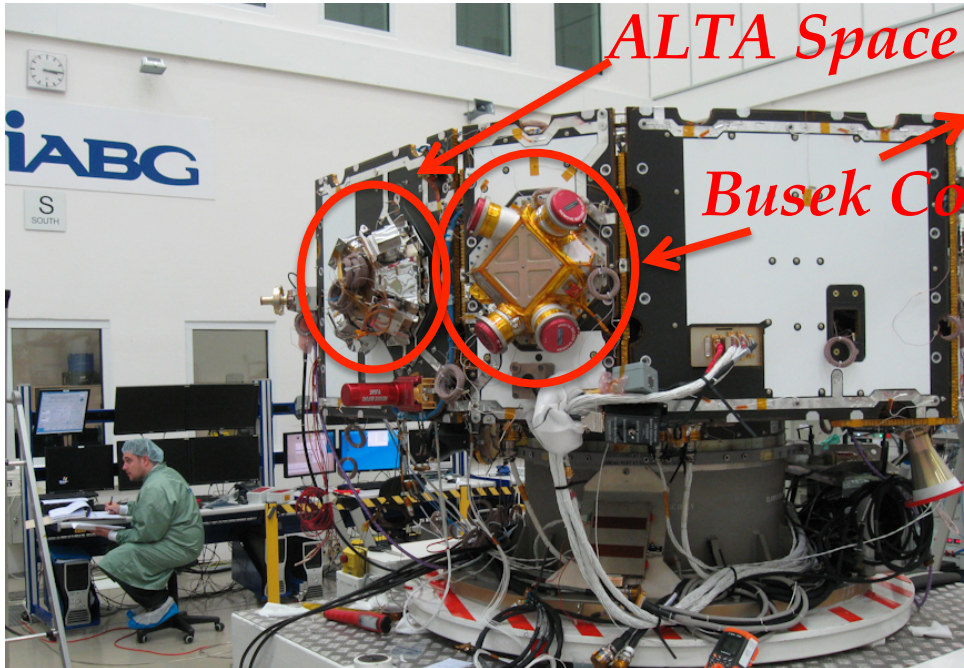
Mass spectrometry
<http://www.rsc.org/chemistryworld/Issues/2003/February/together.asp>

Concept of MicroThrust emitters

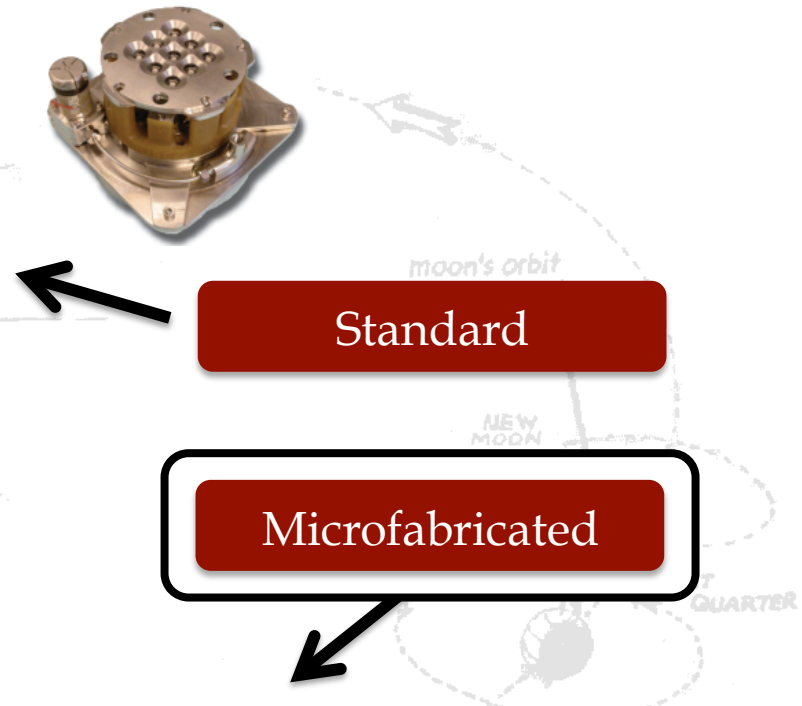
- No pressured tanks/lines (capillary feed)
 - 1.2 bar allowed in CubeSats (*CubeSat Design Specification, Cal. Poly.*)
- No neutralizer
- Variable I_{sp}
 - up to 2 000 – 3 000 s without accelerator
 - “unlimited” with accelerator stage(s) and sufficient power (realistically 5 000 – 10 000 s)
- Variable thrust
 - $\sim 10^{-8}$ N for individual emitters
 - increased with arrays (realistically $\sim 10^{-4}$ N)



Miniaturization through microfabrication



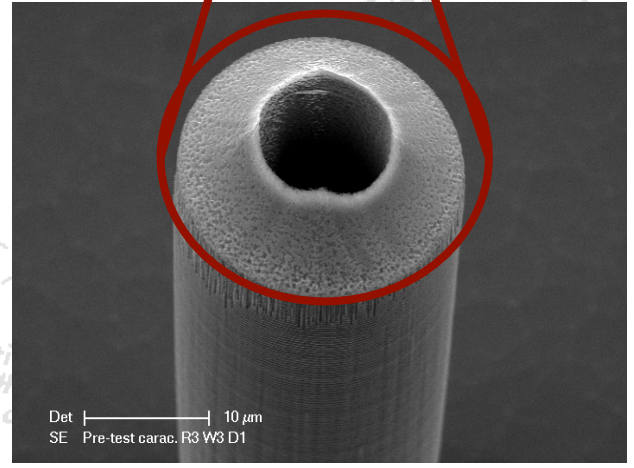
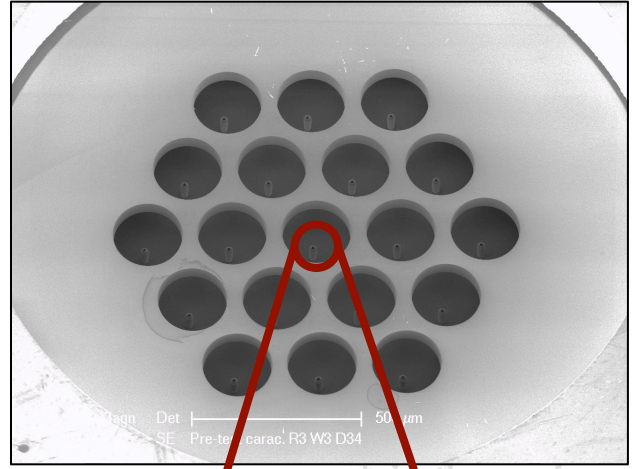
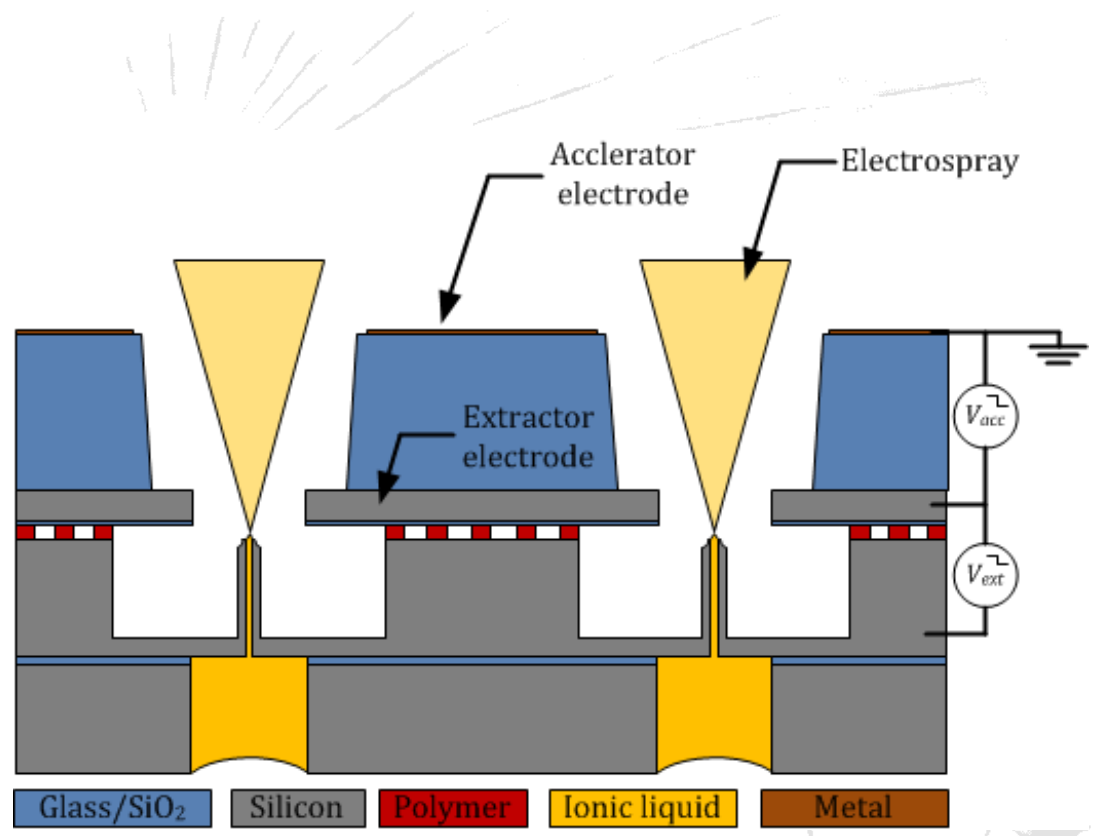
Lisa Pathfinder Spacecraft - Thermal-vacuum test in IABG (Germany) - Sep2011 ©ALTA Space



Advantages of microfabrication	Disadvantages of microfabrication
--------------------------------	-----------------------------------

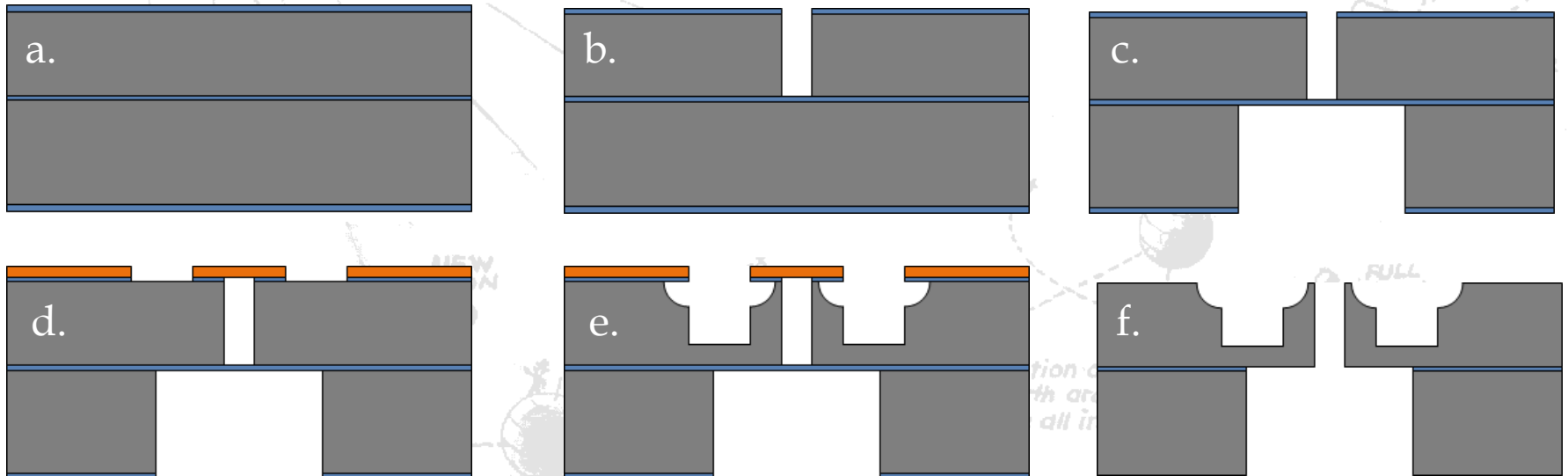
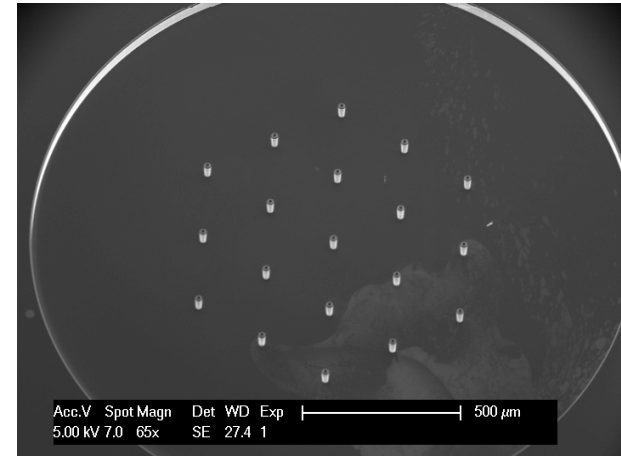
Can achieve very high hydraulic impedance	More difficult to make
Possibility to fabricate large, uniform arrays (thousands)	High development costs
Lower mass and footprint	
High level of integration	

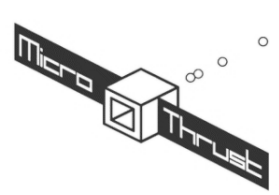
Our design of electrospray emitters



Emitter microfabrication process

- a. Starting SOI Wafer | 100/2/500 μm
- b. DRIE Silicon Etch | Inner Cap. Def.
- c. DRIE Silicon Etch | Backside
- d. Resist lamination & patterning | MX5015
- e. DRIE iso. & aniso. silicon Etch | Outer Cap. Def.
- f. Oxide etch & Wafer Cleaning \rightarrow Release

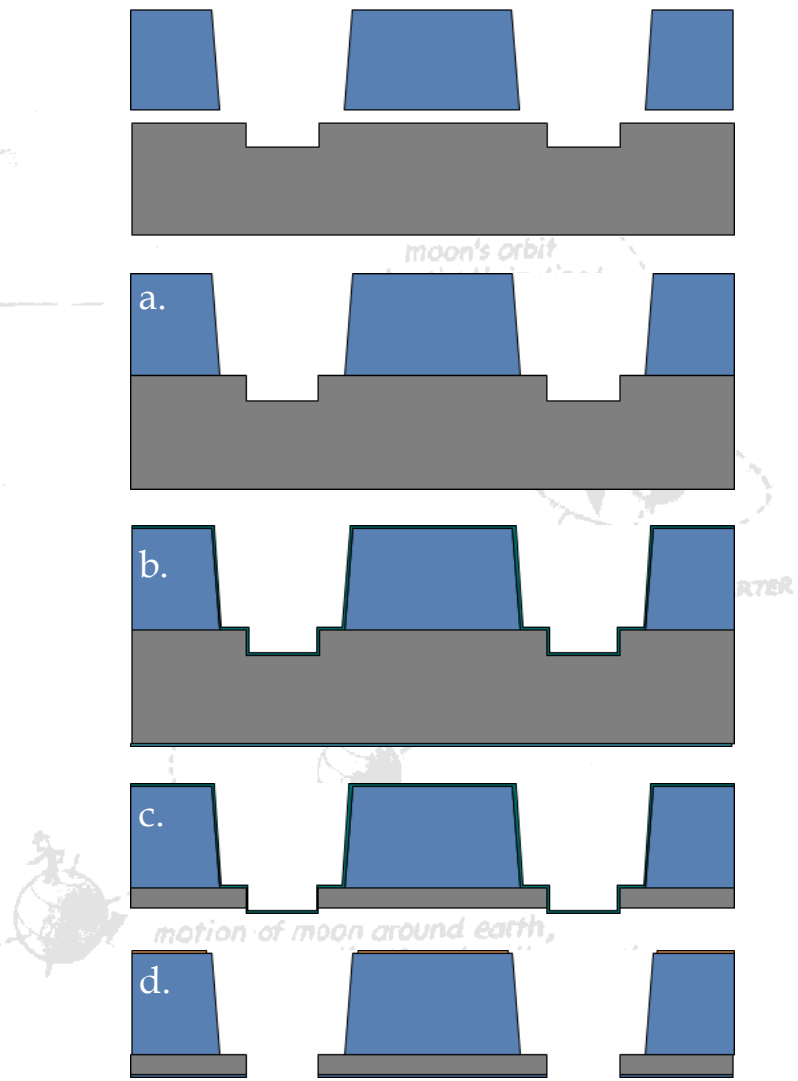
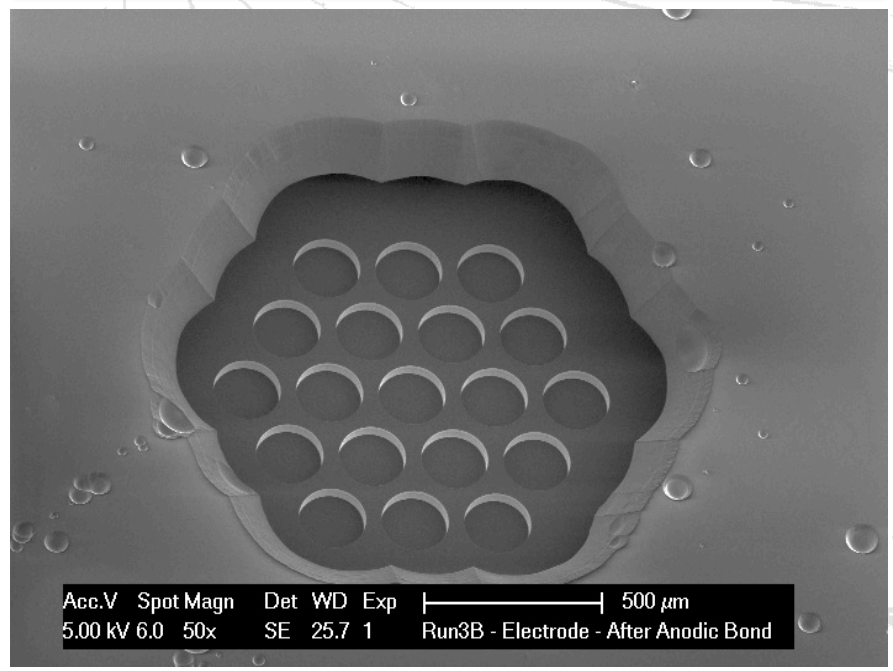




Electrode microfabrication process

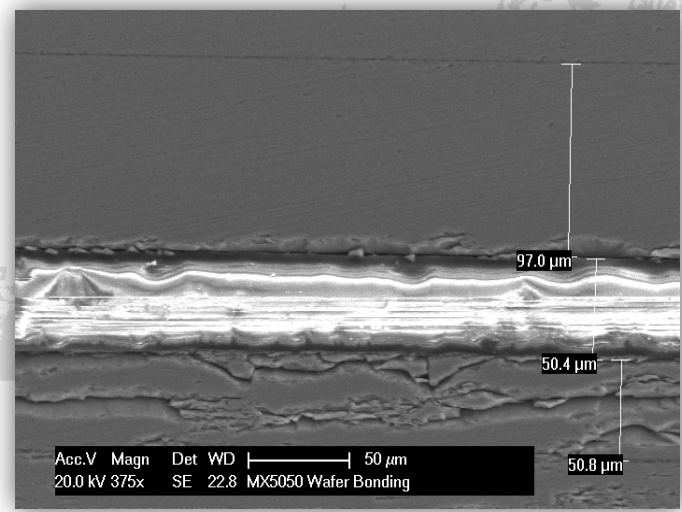
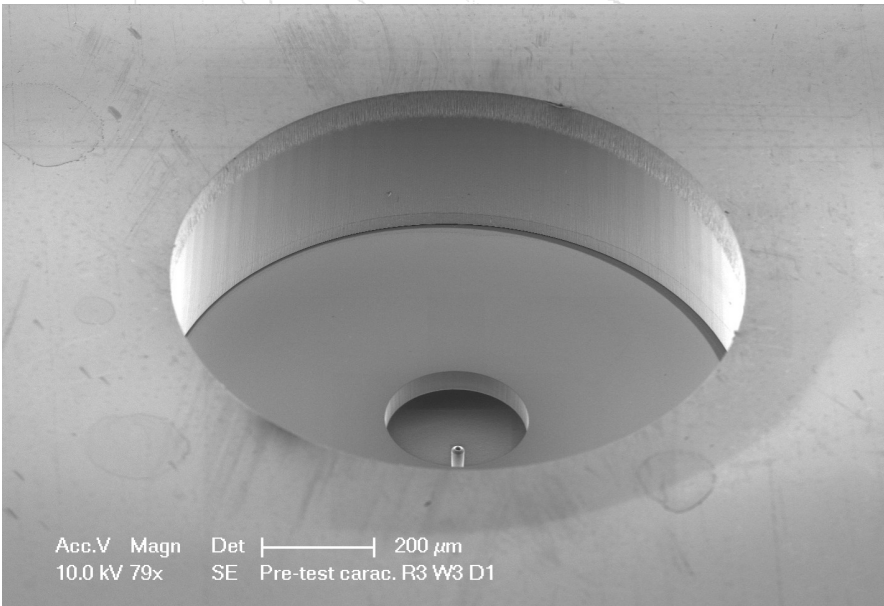
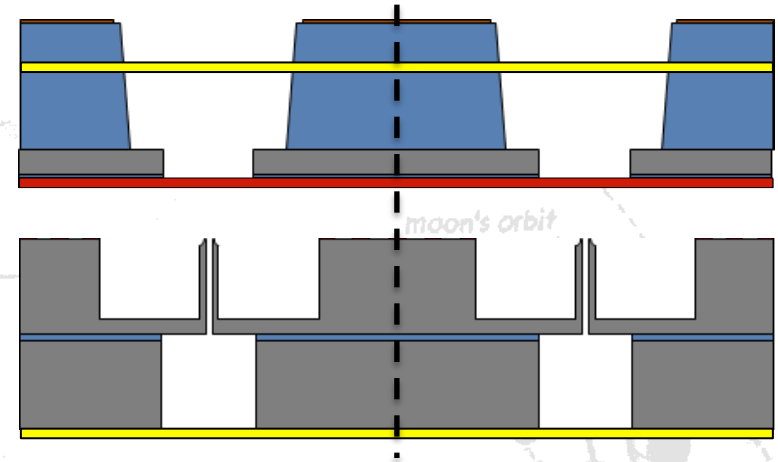
300 μm glass | Patterning: HF/Icoflex.ch/APEX™
300 μm bulk silicon wafer | Patterning: DRIE

- Anodic bonding
- Parylène deposition
- Backgrind & CMP
- SiO₂ sputtering & Metallization

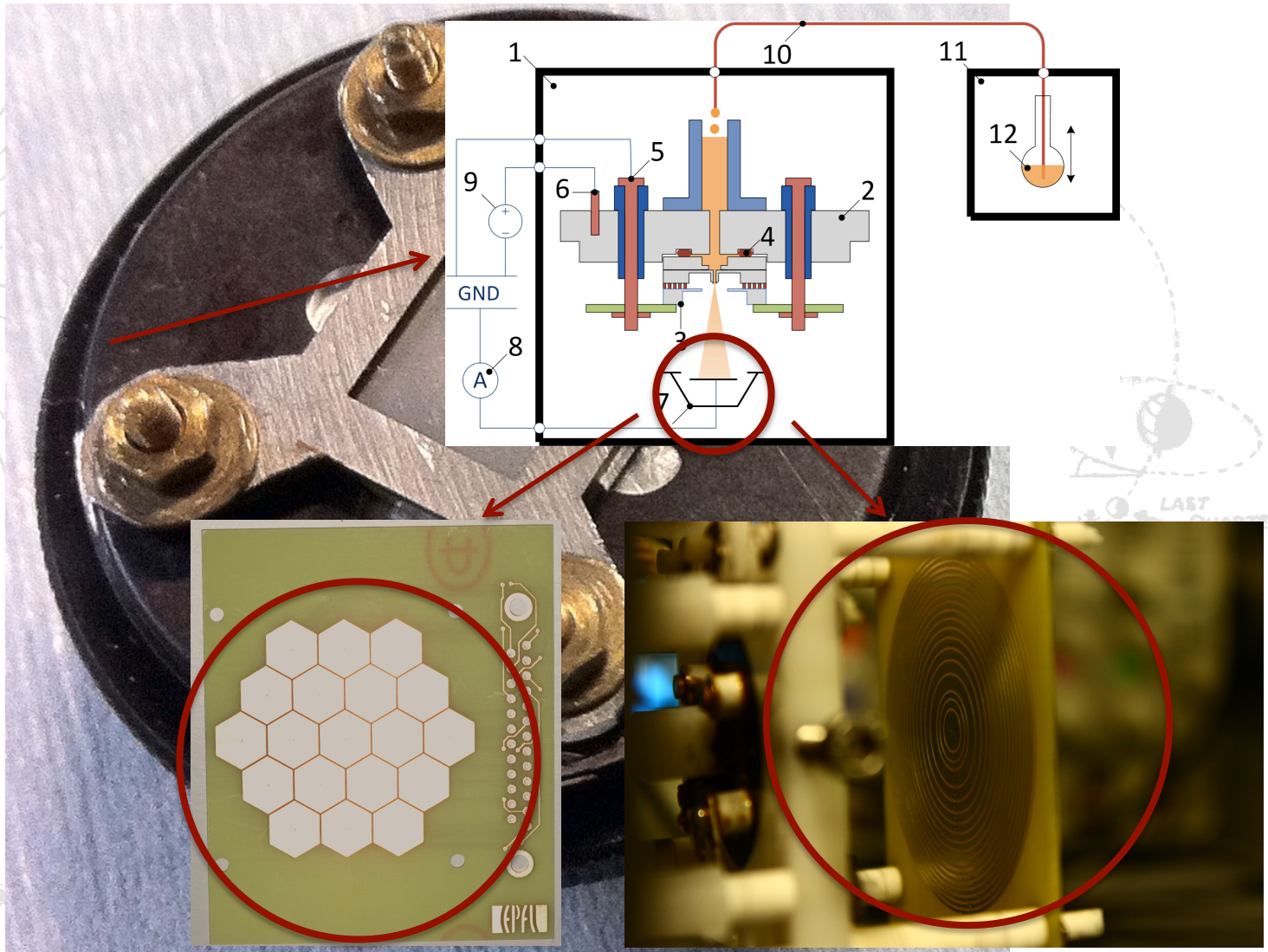


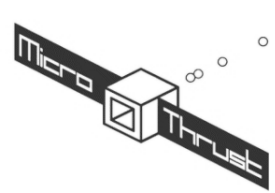
Wafer level assembly

- 1) Extractor & Emitter Wafers
- 2) Dry resist lamination & Photolithography
- 3) Bonding
- 4) Dicing



Evaluating the performance

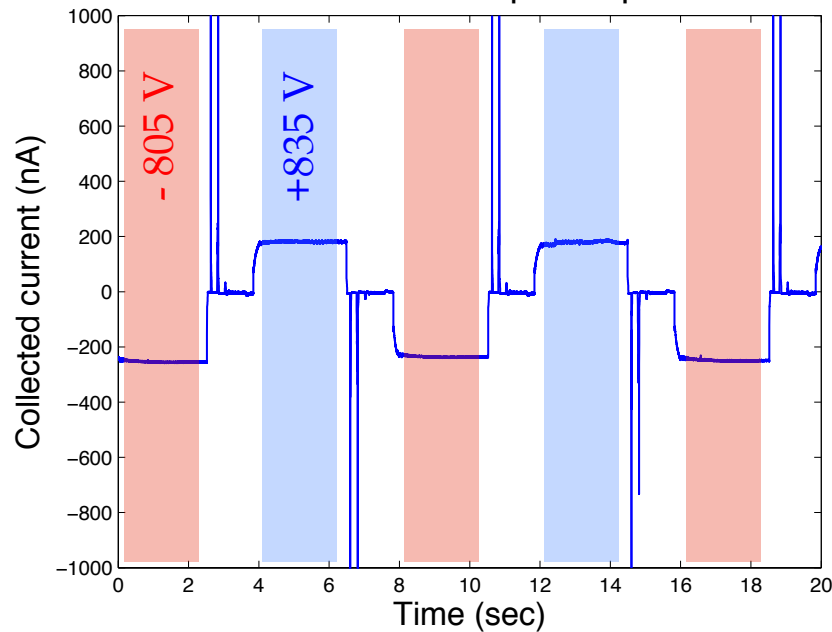




Onset voltage through IV curves

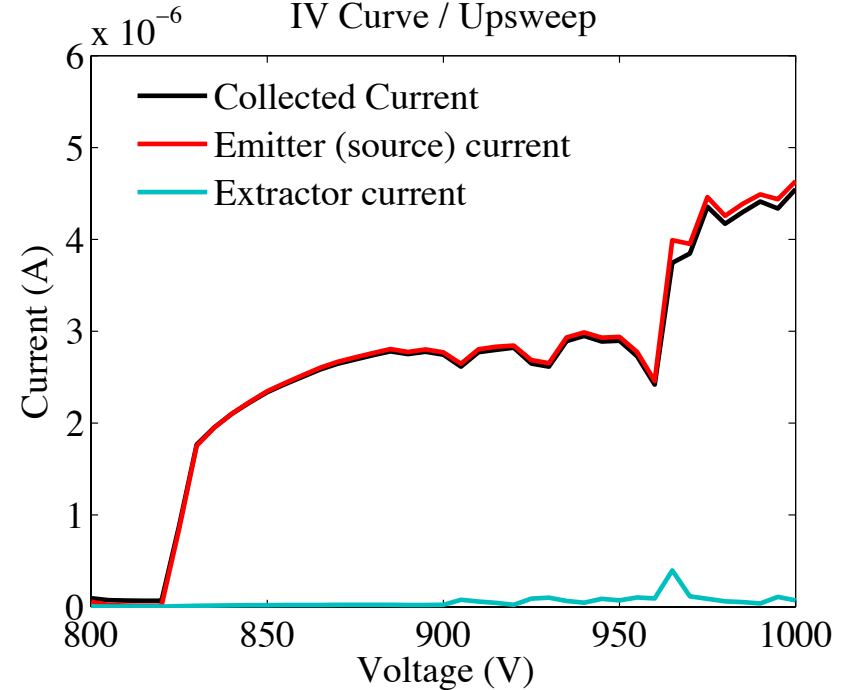
- Onset voltage ~825V
- Current: ~200nA/emitter
- Positive, negative operation

Emitted current in bipolar operation



Single emitter, 200 μ m extractor, after 17 hours bipolar spray with miniature HV supply

IV Curve / Upsweep

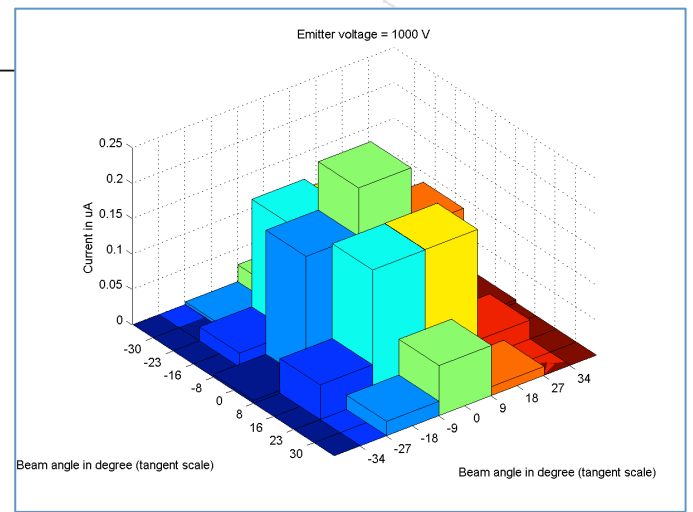
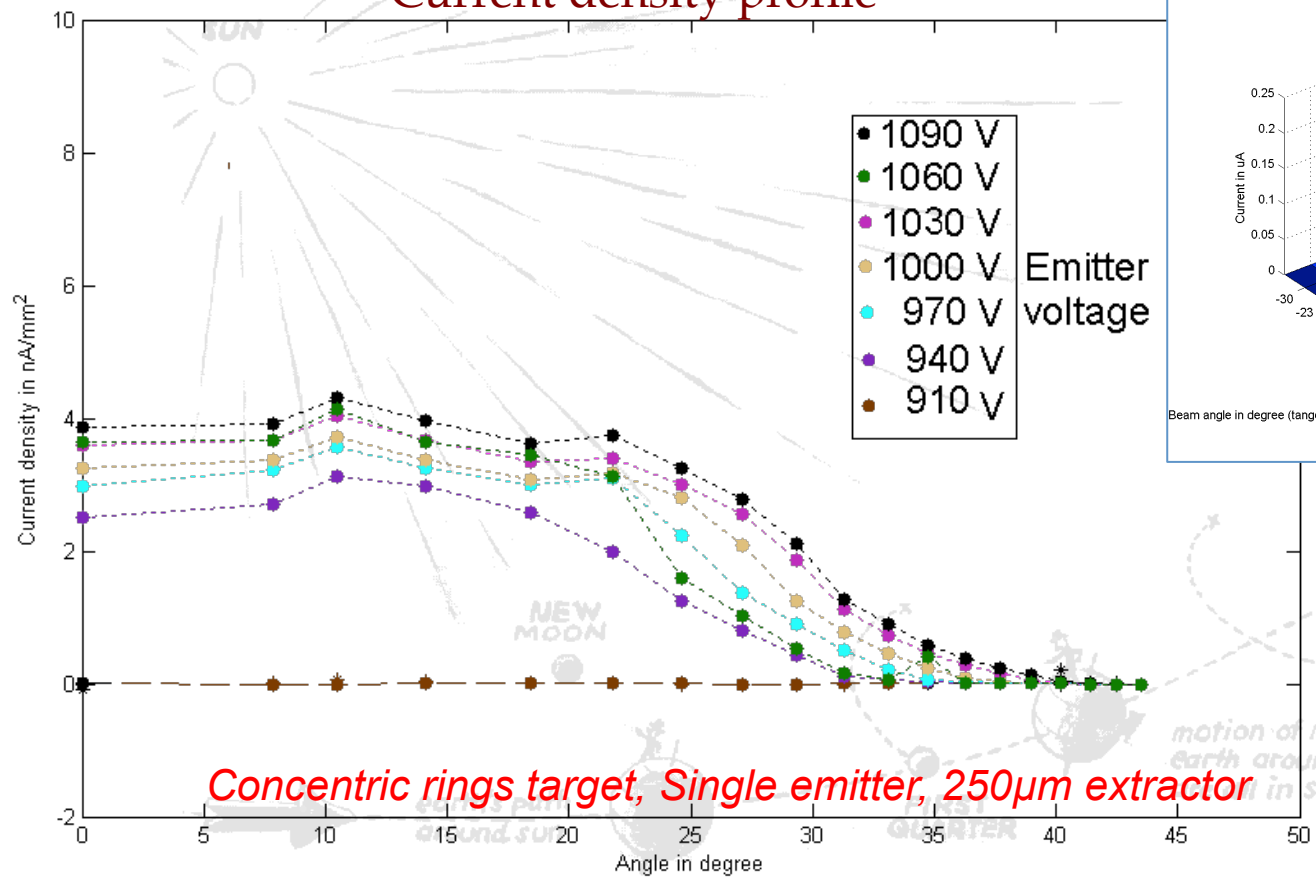


19x array, 200 μ m extractor

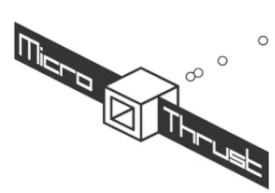
Understanding the beam shape

- Initial characterization: full-angle ~60-80 degrees
 - Beam shape depends on voltage applied (i.e. beam composition)

Current density profile

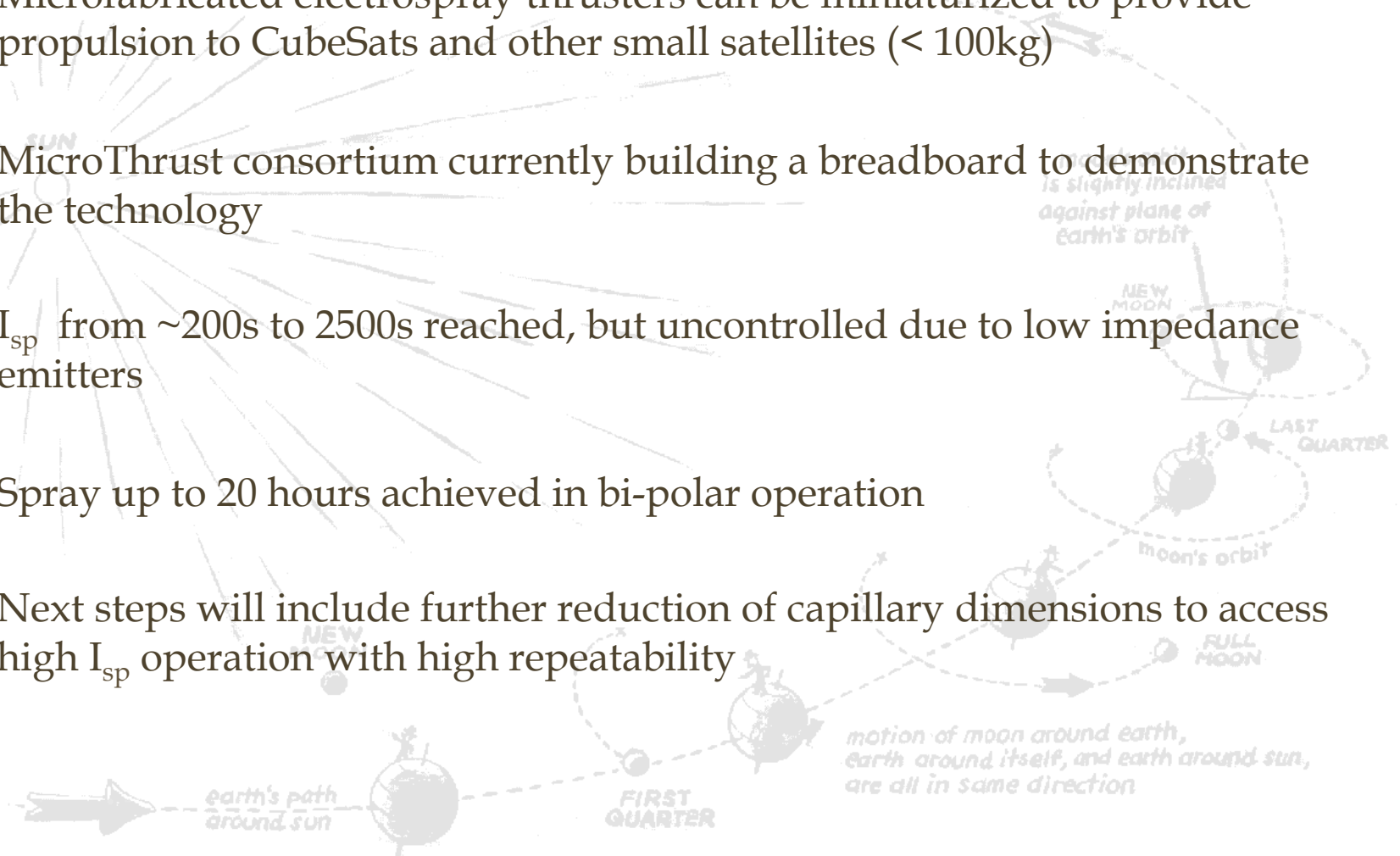


Hexagonal plates target, single emitter, 200 μ m extractor



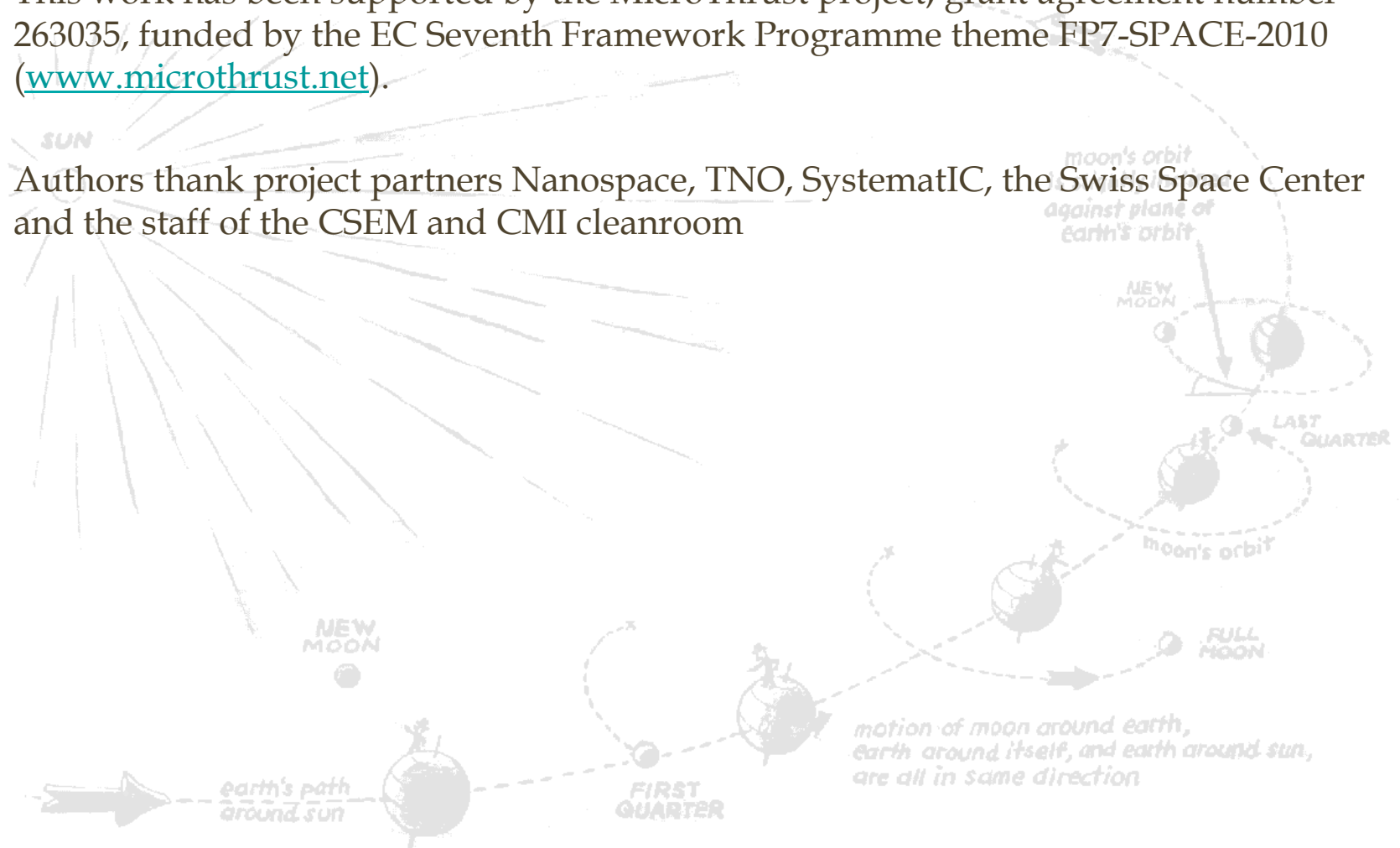
Summary

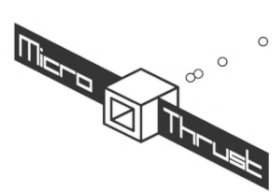
- Microfabricated electrospray thrusters can be miniaturized to provide propulsion to CubeSats and other small satellites (< 100kg)
- MicroThrust consortium currently building a breadboard to demonstrate the technology
- I_{sp} from ~200s to 2500s reached, but uncontrolled due to low impedance emitters
- Spray up to 20 hours achieved in bi-polar operation
- Next steps will include further reduction of capillary dimensions to access high I_{sp} operation with high repeatability



Acknowledgements

- This work has been supported by the MicroThrust project, grant agreement number 263035, funded by the EC Seventh Framework Programme theme FP7-SPACE-2010 (www.microthrust.net).
- Authors thank project partners Nanospace, TNO, SystematIC, the Swiss Space Center and the staff of the CSEM and CMI cleanroom



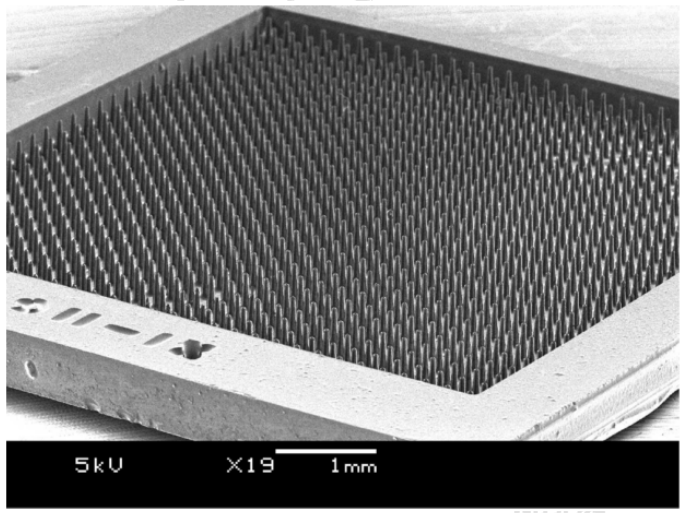


Types of microfabricated emitters

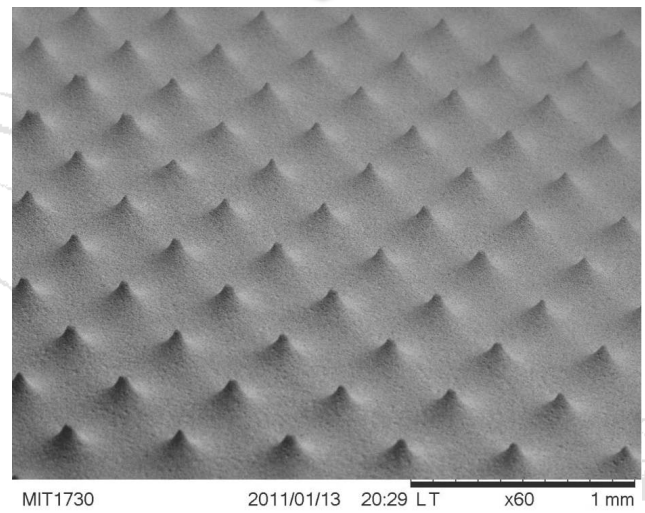
Externally wetted

Porous material

Internally wetted



Velasquez-Garcia, et al. "A planar array of micro-fabricated electro-spray emitters for thruster applications." *Journal of Microelectromechanical Systems* 15, no. 5 (October 2006): 1272–1280.



Porous emitter array, Retrieved from MIT Space propulsion Lab. website, Aug 29 2012: http://web.mit.edu/aeroastro/labs/spl/research_ieps.htm

